

WEVOPUR 403 FL PU encapsulating system

Two-component encapsulating system based on polyurethane.

Attributes

After curing the resin has an excellent flexibility at low temperatures and thermal endurance. WEVOPUR 403 FL ist used with hardener WEVONAT 300 RE. Temperature range of use: -50 °C to +165 °C.

Application

Encapsulation of applications that require high thermal resistance and endurance, like coils, sensors or PCBs. Especially for automotive or ex-proof applications.

Standards

- Class F
- RTI 155 °C
- UL 94 V 0 (1.5 mm)
- UL File E 108835

Delivery forms

30 kg metal container and 250 kg barrel.

Color

WEVOPUR 403 FL: black (standard)

WEVONAT 300 RE: brown

Storage

6 months in closed original containers wiht dry storage between 15 and 25 $^{\circ}\text{C}.$

- Store resin (A component, polyol) and hardener (B component, Isocyanat) dry and at temperatures between 15 °C and 25 °C. Store on pallets or collecting tray and do not expose to draft.
- At temperatures below 15 °C the hardener can crystallise which can be seen by opacity and/or clumps/crystals
 (usually hardeners are clear, transparent liquids in spite of their dark brown colour). In this case the hardener
 should not be used anymore.
- At temperatures higher then 25 °C the sedimentation of fillers contained in the resin component is accelerated. As a consequence it is more difficult to prepare (stir) the resin.

Hardening

Pot life: 30 - 50 min at room temperature, depending on coat thickness and pouring volume.

Curing time: 12 - 24 h at room temperature







Complete chemical curing: 10 - 14 days at room temperature

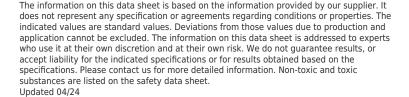
- High air moisture may lead to forming of bubbles. Reference value: the rel. air humidity should not exceed 40
 60 %, depending on the product. To avoid a reaction of the surface curing should be in an air conditioned room, a container with low air moisture or in an oven.
- Elevated temperatures accelerate the curing.
- Curing temperature should not exceed 80 °C to avoid tensions of the resin.
- Final hardness of WEVOPUR 403 FL will be attained after 7 14 days at room temperature.
- This process can be accelerated by post curing at 60 80 °C for 16 24 h. This is relevant for potted components subjec to qualification tests.
- Electrical tests can usually be carried out straight after potting.

Protection

Safety data sheets and the data sheet M044 of the German Chemical Industry Association (BG Chemie) when using the liquid resin.

Processing

- Respect first in first out principle.
- Transfer daily consumption close to the potting area well in advance to allow them to adjust to production hall temperature. Cold material has higher viscosity and flows slower/differently. This can lead to different material pressure on the mix meter machine and thus to inaccurate mix ratio.
- The filler of WEVOPUR 403 FL may sediment. Therefore WEVOPUR 403 FL needs to be homogenized (stirred) prior to use. Homogenize by using e.g. special stir gears (cup stir is better than blade mixing), a drilling machine with top-fitted stir piece or manually with a rod or spatula (no rough-textured wood, splints could get into the resin). Avoid air entrapment during stirring which may lead to humidity (drilling machine with top-fitted stir piece with 100 300 rpm). The sedimented filler needs to be completely homogenized (incl. possible bottom sediments).
- Without sufficient homogenization the top part of the container will contain too much resin (reactive
 component) and in the lower part too much filler. This leads to over/ under cross-linking. The resulting cured
 polyurethane will be too hard or too soft and shows different mechanical, thermal and electrical properties as
 indicated in the technical data sheet.
- Protect both resin and hardener against humidity.
- After homogenization the incorporated air can be removed by using vacuum. Place WEVOPUR 403 FL in the tank and apply vacuum (50 bar) for approx. 30 min while stirring.
- The mixing ratio should be checked and documented daily prior to start of production. Even after short breaks in production it might be useful to check the mixing ratio. Also, the density (dosage of WEVOPUR through mixing head) should be checked. The mixing ratio indicated in the technical data sheets has to be adhered to. Deviations must not be more than 3 % referring to the hardener component.







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Excess hardener can react with humidity leading to formation of carbon dioxide and therefore to air
entrapments. Furthermore excess hardener usually leads to harder material. Excess resin acts as a softener.
 However, a minor low dosage of hardener is usually less critical than an overdosage. It is not recommended to
deviate from the ideal mixing ratio to change the material properties.

Preparation of components

- Humidity adheres to every metal or plastic surface. Because humidity may lead to air entrapment during curing it might be necessary to dry components prior to encapsulating. It is sufficient to dry components for 1
 2 hours at 60 80 °C in the oven. Pre-drying is particularly important for coilable materials.
- The sensitivity of encapsulating systems and hardeners against humidity and the humidity content of various plastic surfaces varies. Please consult with Synflex regarding isolated cases.
- Pre-heating of components has a positive influence on the flow behaviour of the resin. The warm component
 heats up the resin thus lowering viscosity. The resin penetrates the component faster and displaced air can
 ascent faster. The higher the component's temperature, the better the resin flows. Component temperatures
 of up to 80 °C do not affect the uncured resin.
- Pre-heated components do also accelerate curing.

Cleaning

Since the cured resin is practically insoluble, tools and equipment have to be cleaned in sufficient time.







| Mechanical | Unit of measure | Conditions | Value | Test method |
|---------------------|-----------------|------------|---------|--------------------------------------|
| Shore-D-hardness | | 3 sec | 40 - 50 | acc. ISO 7619-1 |
| Tensile strength | N/mm² | | 9 | ISO 527-2 |
| Elongation at break | % | | 40 | ISO 527-2 |
| E module | N/mm² | | 110 | ISO 527-2 |
| Water absorption | % | | 0.6 | after 30 days storage in water |
| Burning behaviour | | 1.5 mm | V-0 | UL 94 |

| Thermal | Unit of measure | Condition | Value | Test method |
|------------------------------|--------------------|-----------|-------|-------------------------------|
| Thermal conductivity | W/m*K | | 0.73 | DIN EN ISO 22007-2:2015-12 |
| Glass transition temperature | °C | | -6 | TMA ISO 11359-2:2021-11 |
| Coefficient of expansion | ppm/K | <-10 °C | 42 | TMA ISO 11359-2:2021-11 |
| Coeficient of expansion | ppm/K | >5 °C | 146 | TMA ISO 11359-2:2021-11 |
| Thermal class | | | F | IEC 60085 |







| Electrical | Unit of measure | Value | Test method |
|---|--------------------|-------|-----------------------|
| Dielectric strength | kV/mm | 30 | DIN EN 60243 |
| Specific volume resistance | Ω*cm | 10^14 | DIN EN 62631-3-1:2016 |
| Surface resistivity at 23°C and 50 % r.h. | Ω | 10^15 | DIN EN 62631-3-2:2016 |
| Dielectric constant ε at 50 Hz, 23 °C | | 5.7 | DIN EN 60250 |
| Dielectric constant; at 1 kHz, 23 °C | | 5.3 | DIN EN 60250 |
| Dielectric constant ε at 1 MHz, 23 °C | | 4.7 | DIN EN 60250 |
| Dielectric loss factor tan б at 50 Hz, 23 °C | | 0.04 | DIN EN 60250 |
| Dielectric loss factor tan б at 1 kHz, 23 °C | | 0.04 | DIN EN 60250 |
| Dielectric loss factor tan б at 1 MHz, 23 °C | | 0.03 | DIN EN 60250 |

| Liquid phase | Unit of measure | WEVOPUR 403 FL | WEVONAT 300 RE | Resin/hardener-mixture |
|----------------------|-----------------|-------------------|-------------------|------------------------|
| Mixing ratio | weight-% | 100 | 14 weight-% | |
| Viscosity (22 °C) | mPas | 12.000-18.000 | 10-40 | 2,000-3,000 |
| Density (22 °C) | g/cm³ | 1.62-1.68 | 1.20-1.24 | |





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